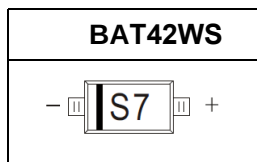


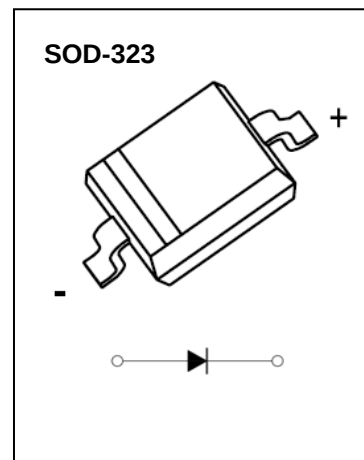
FEATURES

- Low Forward Voltage Drop
- Fast Switching Time
- Surface Mount Package Ideally Suited for Automatic Insertion

MARKING:



SOD-323 Plastic-Encapsulate Diodes



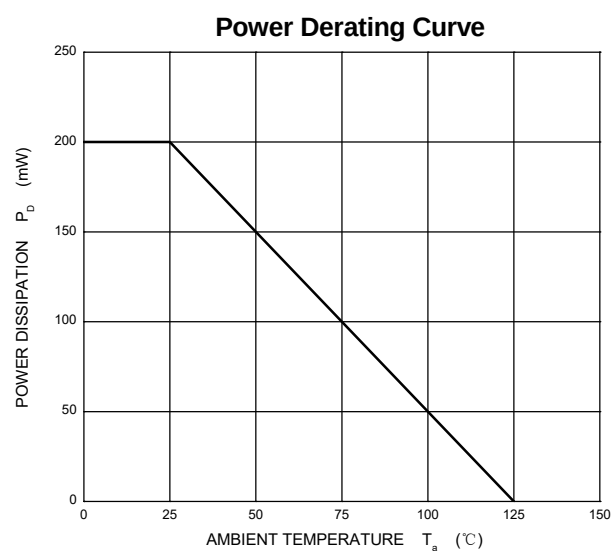
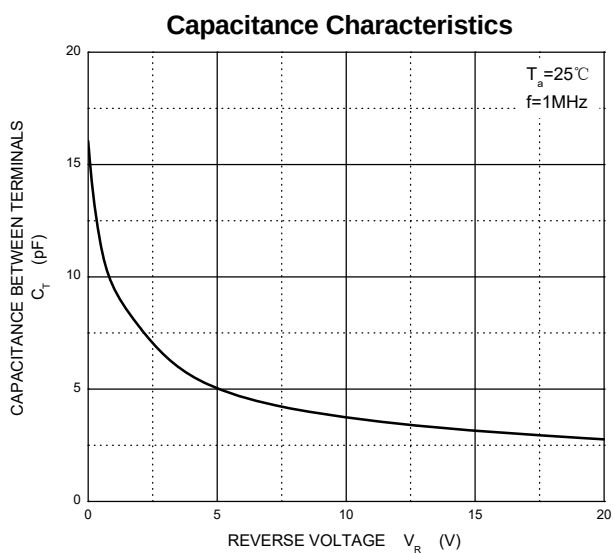
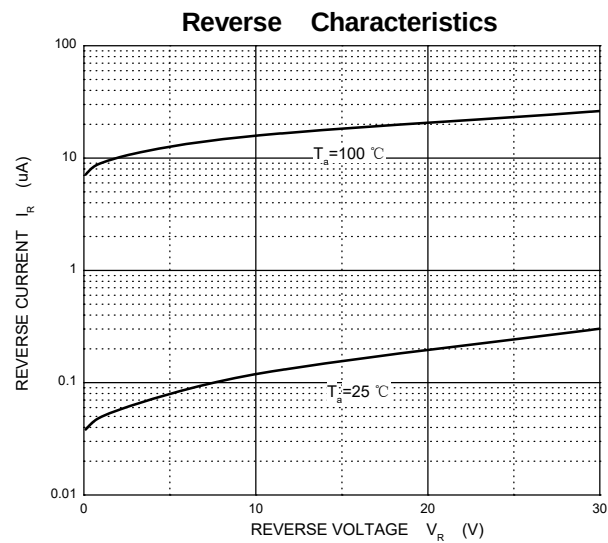
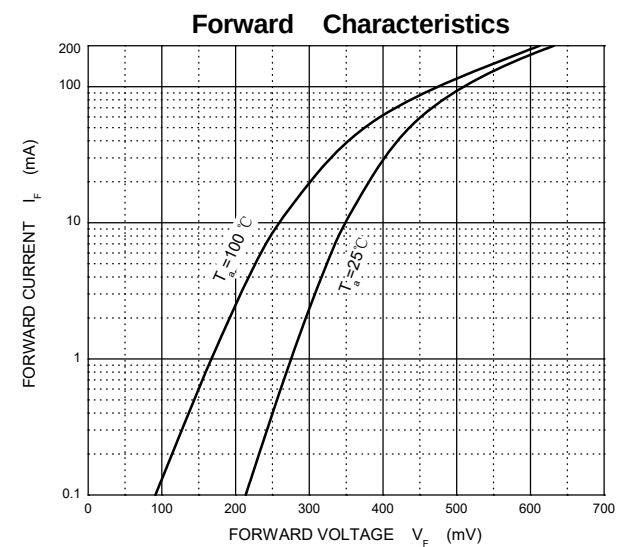
Maximum Ratings and Electrical Characteristics, Single Diode @Ta=25°C

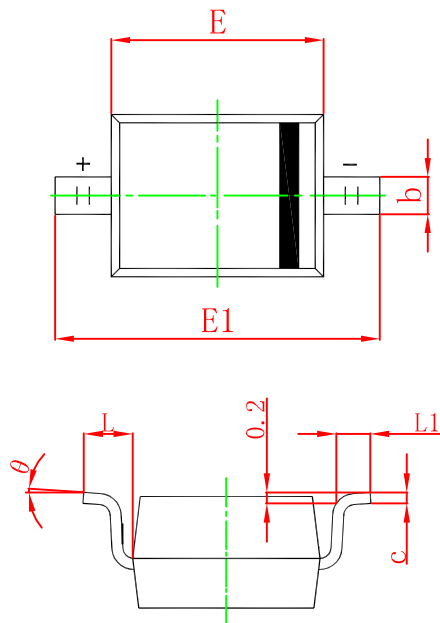
Parameter	Symbol	Limit	Unit
Peak Repetitive Peak Reverse Voltage	V_{RRM}	30	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	21	V
Forward Continuous Current	I_{FM}	200	mA
Repetitive Peak Forward Current @t<1.0s	I_{FRM}	500	mA
Non-repetitive Peak Forward Surge Current @t=8.3ms	I_{FSM}	4.0	A
Power Dissipation	P_D	200	mW
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	500	°C/W
Operating Junction Temperature Range	T_J	-40 ~ +125	°C
Storage Temperature Range	T_{STG}	-55 ~ +150	°C

Electrical Ratings @Ta=25°C

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Reverse breakdown voltage	$V_{(BR)}$	30			V	$I_R=10\mu A$
Forward voltage	Both Types			1.0	V	$I_F=200mA$
	BAT42WS			0.4	V	$I_F=10mA$
	BAT42WS			0.65	V	$I_F=50mA$
	BAT42WS	0.26		0.33	V	$I_F=2mA$
	BAT42WS			0.45	V	$I_F=15mA$
Reverse current	I_R			0.5	μA	$V_R=25V$
Capacitance between terminals	C_T			10	pF	$V_R=1.0V, f=1.0MHz$
Reverse recovery time	t_{rr}			5	ns	$I_F=I_R=10mA$ $I_{rr}=0.1I_R, R_L=100\Omega$

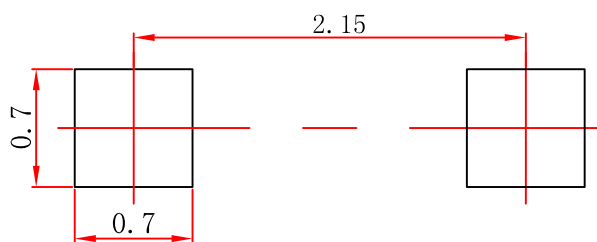
Typical Characteristics





Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A		1.100		0.043
A1	0.000	0.100	0.000	0.004
A2	0.800	1.000	0.031	0.039
b	0.250	0.350	0.010	0.014
c	0.080	0.150	0.003	0.006
D	1.200	1.400	0.047	0.055
E	1.600	1.800	0.063	0.071
E1	2.500	2.750	0.098	0.108
L	0.475 REF		0.019 REF	
L1	0.250	0.400	0.010	0.016
θ	0°	8°	0°	8°

SOD-323 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.